

BUJD105AD

NPN power transistor with integrated diode

Rev. 01 — 8 May 2009

Product data sheet

1. Product profile

1.1 General description

High voltage, high speed, planar passivated NPN power switching transistor with integrated anti-parallel E-C diode in a SOT428 (DPAK) surface-mountable plastic package.

1.2 Features and benefits

- Fast switching
- High voltage capability
- Very low switching and conduction losses

1.3 Applications

- DC-to-DC converters
- Electronic lighting ballasts
- Inverters
- Motor control systems

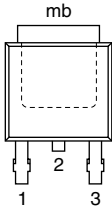
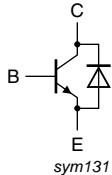
1.4 Quick reference data

Table 1. Quick reference

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------------|--------------------------------|--|-----|------|-----|------|
| I_C | collector current | | - | - | 8 | A |
| P_{tot} | total power dissipation | $T_{mb} \leq 25\text{ °C}$; see Figure 3 | - | - | 80 | W |
| V_{CESM} | collector-emitter peak voltage | $V_{BE} = 0\text{ V}$ | - | - | 700 | V |
| Static characteristics | | | | | | |
| h_{FE} | DC current gain | $V_{CE} = 5\text{ V}$; $I_C = 4\text{ A}$; $T_{mb} = 25\text{ °C}$; see Figure 6 ; see Figure 7 | 8 | 13.5 | - | |

2. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|---------------------------------------|---|---|
| 1 | B | base |  <p>SOT428 (SC-63; DPAK)</p> |  |
| 2 | C | collector | | |
| 3 | E | emitter | | |
| mb | C | mounting base; connected to collector | | |

[1] It is not possible to make a connection to pin 2 of the SOT428 (DPAK) package.

3. Ordering information

Table 3. Ordering information

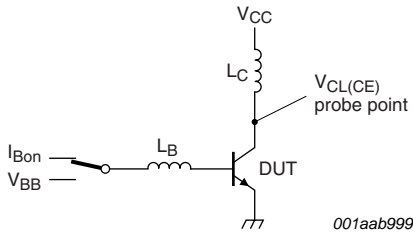
| Type number | Package | | Version |
|-------------|----------------|---|---------|
| | Name | Description | |
| BUJD105AD | SC-63; DPAK | plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped) | SOT428 |

4. Limiting values

Table 4. Limiting values

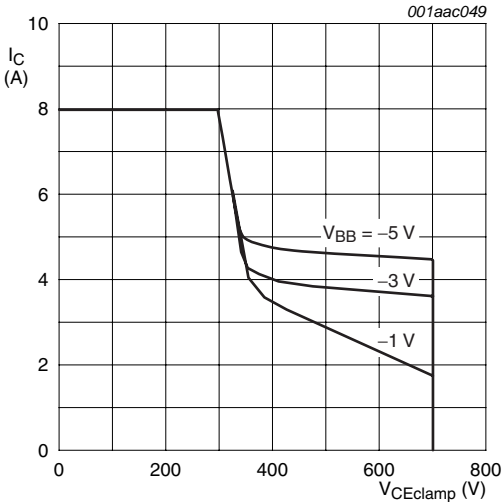
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------|--------------------------------|--|-----|-----|------------------|
| V_{CESM} | collector-emitter peak voltage | $V_{BE} = 0 \text{ V}$ | - | 700 | V |
| V_{CBO} | collector-base voltage | $I_E = 0 \text{ A}$ | - | 700 | V |
| V_{CEO} | collector-emitter voltage | $I_B = 0 \text{ A}$ | - | 400 | V |
| I_C | collector current | | - | 8 | A |
| I_{CM} | peak collector current | see Figure 1 ; see Figure 2 | - | 16 | A |
| I_B | base current | | - | 4 | A |
| I_{BM} | peak base current | | - | 8 | A |
| P_{tot} | total power dissipation | $T_{mb} \leq 25 \text{ }^\circ\text{C}$; see Figure 3 | - | 80 | W |
| T_{stg} | storage temperature | | -65 | 150 | $^\circ\text{C}$ |
| T_j | junction temperature | | - | 150 | $^\circ\text{C}$ |



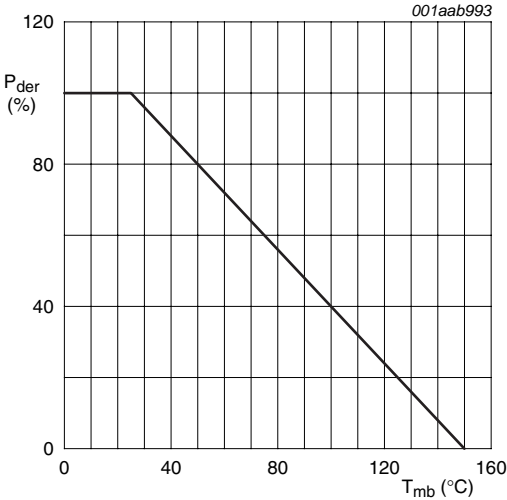
$V_{CEclamp} \leq 1000\text{ V}; V_{CC} = 150\text{ V};$
 $V_{BB} = -5\text{ V}; L_B = 1\text{ }\mu\text{H}; L_C = 200\text{ }\mu\text{H}$

Fig 1. Test circuit for reverse bias safe operating area



$$T_j \leq T_{j(max)}\text{ }^{\circ}\text{C}$$

Fig 2. Reverse bias safe operating area



$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}\text{C})}} \times 100\%$$

Fig 3. Normalized total power dissipation as a function of mounting base temperature

5. Thermal characteristics

Table 5. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|----------------|---|--|-----|-----|------|------|
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base | see Figure 4 | - | - | 1.56 | K/W |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | printed-circuit-board mounted; minimum footprint; see Figure 5 | - | 75 | - | K/W |

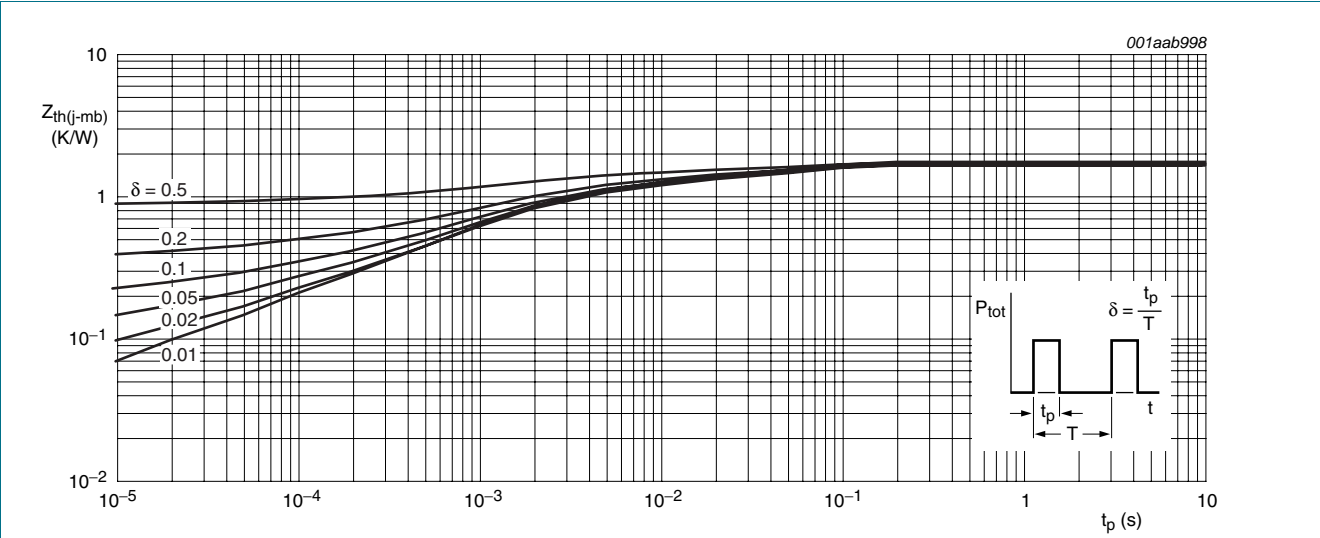
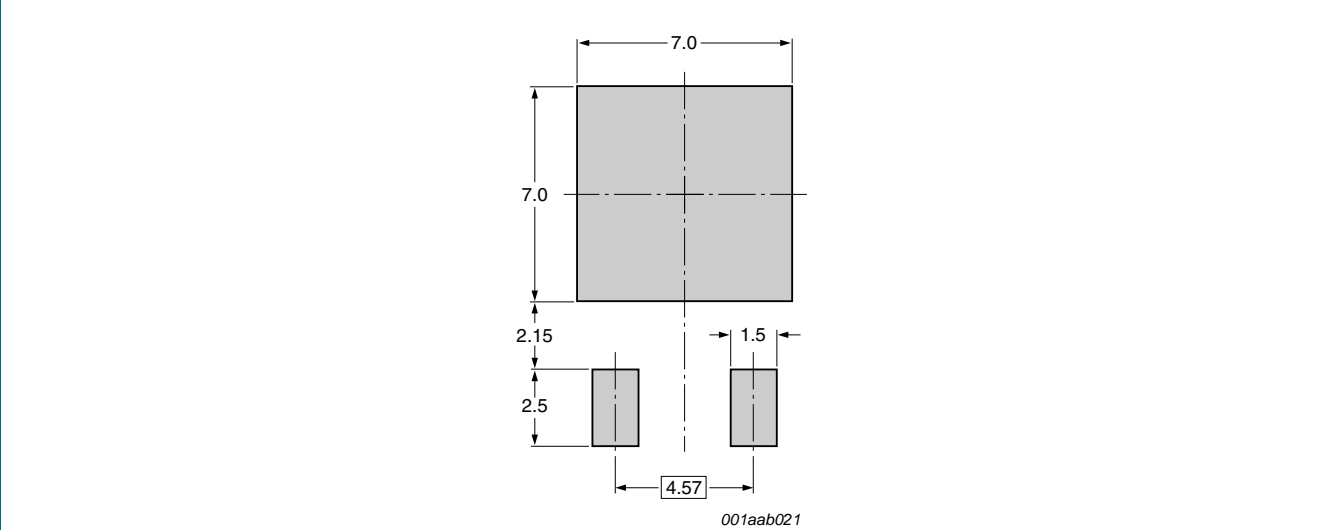


Fig 4. Transient thermal impedance from junction to mounting base as a function of pulse width



all dimensions are in mm

Fig 5. Minimum footprint SOT428

6. Characteristics

Table 6. Characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------------------------------|--------------------------------------|---|-----|------|-----|---------------|
| Static characteristics | | | | | | |
| h_{FE} | DC current gain | $V_{CE} = 5\text{ V}$; $I_C = 4\text{ A}$; $T_{mb} = 25\text{ °C}$; see Figure 6 ; see Figure 7 | 8 | 13.5 | - | |
| | | $V_{CE} = 5\text{ V}$; $I_C = 1\text{ mA}$; $T_{mb} = 25\text{ °C}$ | 10 | 17 | 34 | |
| | | $V_{CE} = 5\text{ V}$; $I_C = 500\text{ mA}$; $T_{mb} = 25\text{ °C}$ | 13 | 23 | 36 | |
| I_{CBO} | collector-base cut-off current | $I_E = 0\text{ A}$; $V_{CB} = 700\text{ V}$ [1] | - | - | 0.2 | mA |
| I_{CEO} | collector-emitter cut-off current | $I_B = 0\text{ A}$; $V_{CE} = 400\text{ V}$ [1] | - | - | 0.1 | mA |
| I_{CES} | collector-emitter cut-off current | $V_{CE} = 700\text{ V}$; $V_{BE} = 0\text{ V}$; $T_j = 25\text{ °C}$ [1] | - | - | 0.2 | mA |
| | | $V_{CE} = 700\text{ V}$; $V_{BE} = 0\text{ V}$; $T_j = 125\text{ °C}$ [1] | - | - | 0.5 | mA |
| I_{EBO} | emitter-base cut-off current | $I_C = 0\text{ A}$; $V_{EB} = 9\text{ V}$ | - | - | 10 | mA |
| V_{BEsat} | base-emitter saturation voltage | $I_C = 4\text{ A}$; $I_B = 0.8\text{ A}$; see Figure 8 | - | 1 | 1.5 | V |
| V_{CEOsus} | collector-emitter sustaining voltage | $I_B = 0\text{ A}$; $L_C = 25\text{ mH}$; $I_C = 10\text{ mA}$; see Figure 9 ; see Figure 10 | 400 | - | - | V |
| V_{CEsat} | collector-emitter saturation voltage | $I_B = 0.8\text{ A}$; $I_C = 4\text{ A}$; see Figure 11 ; see Figure 12 | - | 0.3 | 1 | V |
| V_F | forward voltage | $I_F = 4\text{ A}$ | - | 1.07 | 1.5 | V |
| Dynamic characteristics | | | | | | |
| t_f | fall time | $I_C = 5\text{ A}$; $I_{B(on)} = 1\text{ A}$; $V_{BB} = -5\text{ V}$; $L_B = 1\text{ }\mu\text{H}$; inductive load; $T_{mb} = 25\text{ °C}$; see Figure 13 ; see Figure 14 | - | 20 | 50 | ns |
| | | $I_C = 5\text{ A}$; $I_{B(on)} = 1\text{ A}$; $V_{BB} = -5\text{ V}$; $L_B = 1\text{ }\mu\text{H}$; inductive load; $T_{mb} = 100\text{ °C}$ | - | 25 | 100 | ns |
| | | $I_C = 5\text{ A}$; $I_{B(on)} = 1\text{ A}$; $I_{B(off)} = -1\text{ A}$; $R_L = 75\text{ }\Omega$; resistive load; $T_j = 25\text{ °C}$; see Figure 15 ; see Figure 16 | - | 0.3 | 0.5 | μs |
| t_{on} | turn-on time | $I_C = 5\text{ A}$; $I_{B(on)} = 1\text{ A}$; $I_{B(off)} = -1\text{ A}$; $R_L = 75\text{ }\Omega$; $T_j = 25\text{ °C}$; resistive load | - | 0.65 | 1 | μs |
| t_s | storage time | $I_C = 5\text{ A}$; $I_{B(on)} = 1\text{ A}$; $I_{B(off)} = -1\text{ A}$; $R_L = 75\text{ }\Omega$; resistive load; $T_j = 25\text{ °C}$ | - | 1.8 | 2.5 | μs |
| | | $I_C = 5\text{ A}$; $I_{B(on)} = 1\text{ A}$; $R_L = 75\text{ }\Omega$; inductive load; $T_j = 25\text{ °C}$; $L_B = 1\text{ }\mu\text{H}$; $V_{BB} = -5\text{ V}$ | - | 1.2 | 1.7 | μs |
| | | $I_C = 5\text{ A}$; $I_{B(on)} = 1\text{ A}$; $I_{B(off)} = -1\text{ A}$; inductive load; $T_j = 100\text{ °C}$; $L_B = 1\text{ }\mu\text{H}$; $V_{BB} = -5\text{ V}$ | - | 1.4 | 1.9 | μs |

[1] Measured with half sine-wave voltage (curve tracer).

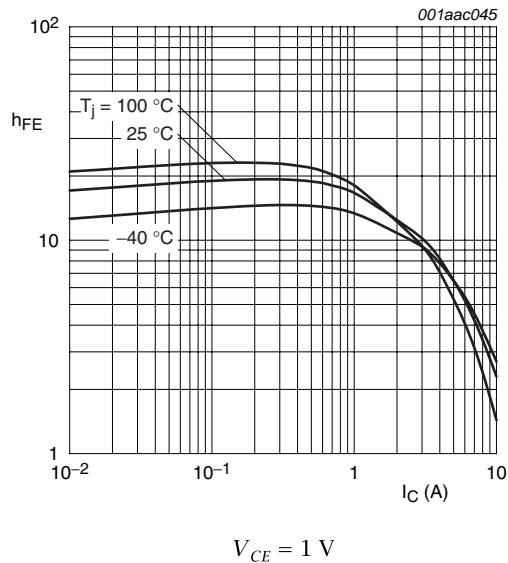


Fig 6. DC current gain as a function of collector current; typical values

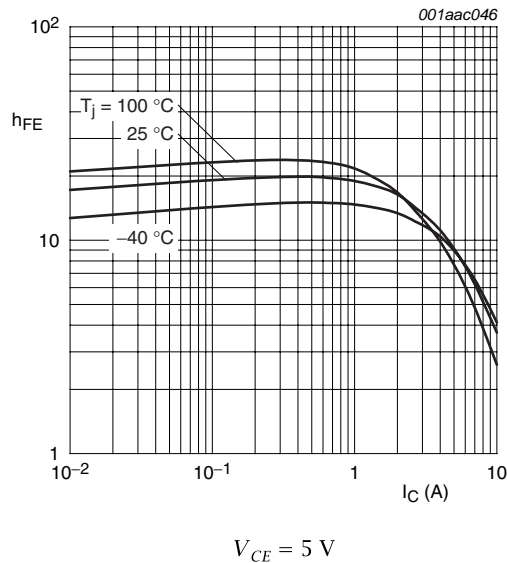


Fig 7. DC current gain as a function of collector current; typical values

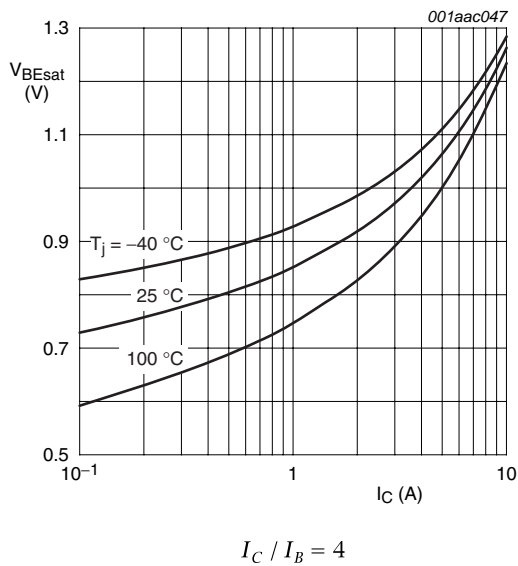


Fig 8. Base-emitter saturation voltage as a function of collector current; typical values

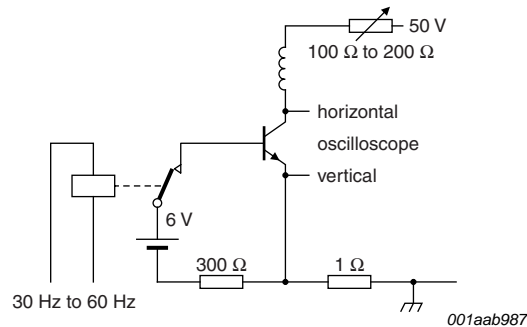


Fig 9. Test circuit for collector-emitter sustaining voltage

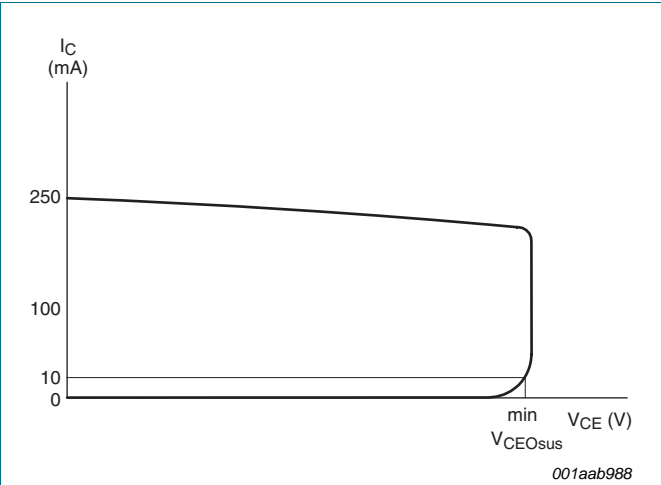


Fig 10. Oscilloscope display for collector-emitter sustaining voltage test waveform

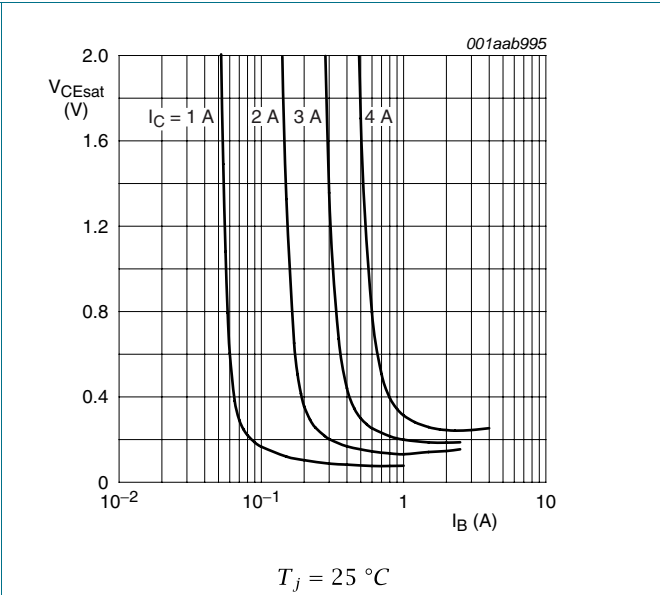


Fig 11. Collector-emitter saturation voltage as a function of base current; typical values

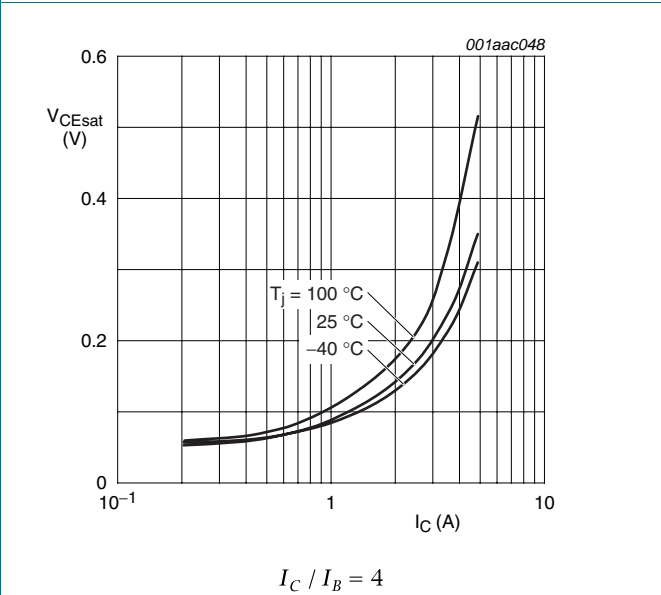


Fig 12. Collector-emitter saturation voltage as a function of collector current; typical values

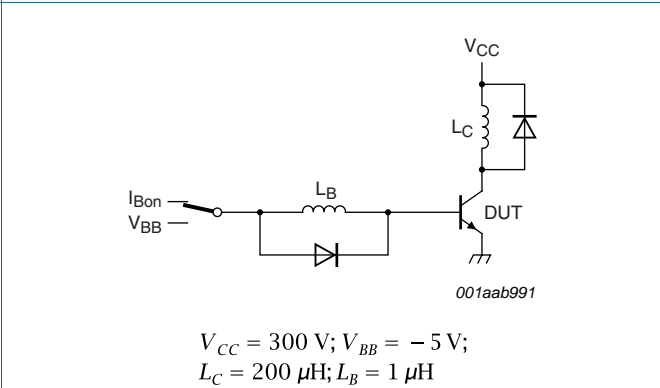


Fig 13. Test circuit for inductive load switching

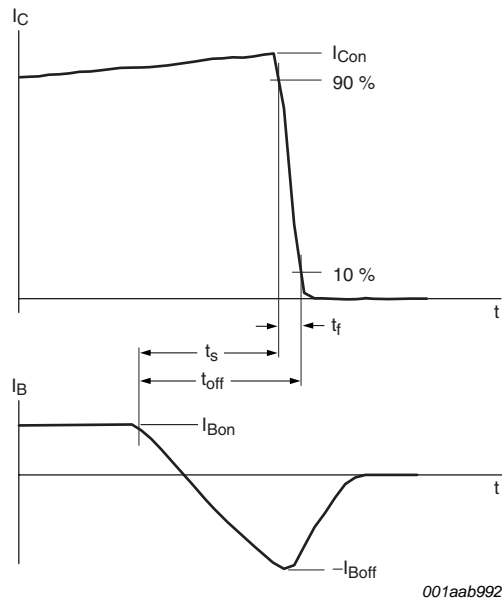
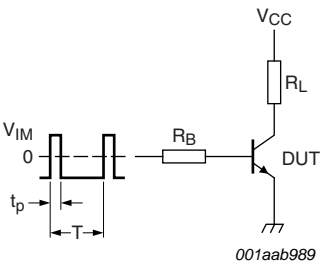


Fig 14. Switching times waveforms for inductive load



$V_{IM} = -6\text{ V to }+8\text{ V}; V_{CC} = 250\text{ V};$
 $t_p = 20\text{ }\mu\text{s}; \delta = t_p/T = 0.01$
 R_B and R_L calculated from I_{Con} and I_{Bon} requirements

Fig 15. Test circuit for resistive load switching

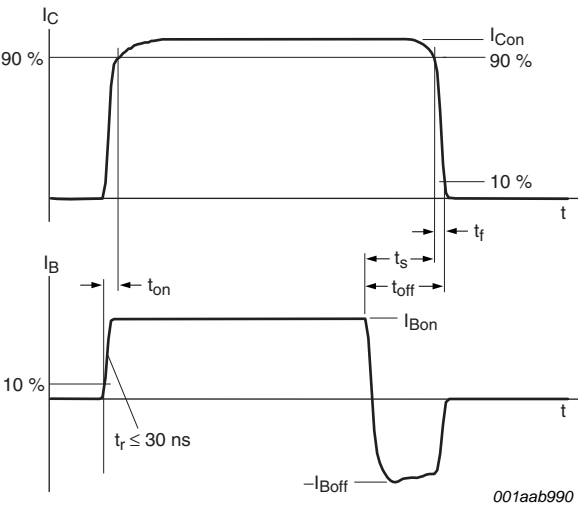


Fig 16. Switching times waveforms for resistive load

7. Package outline

Plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped)

SOT428

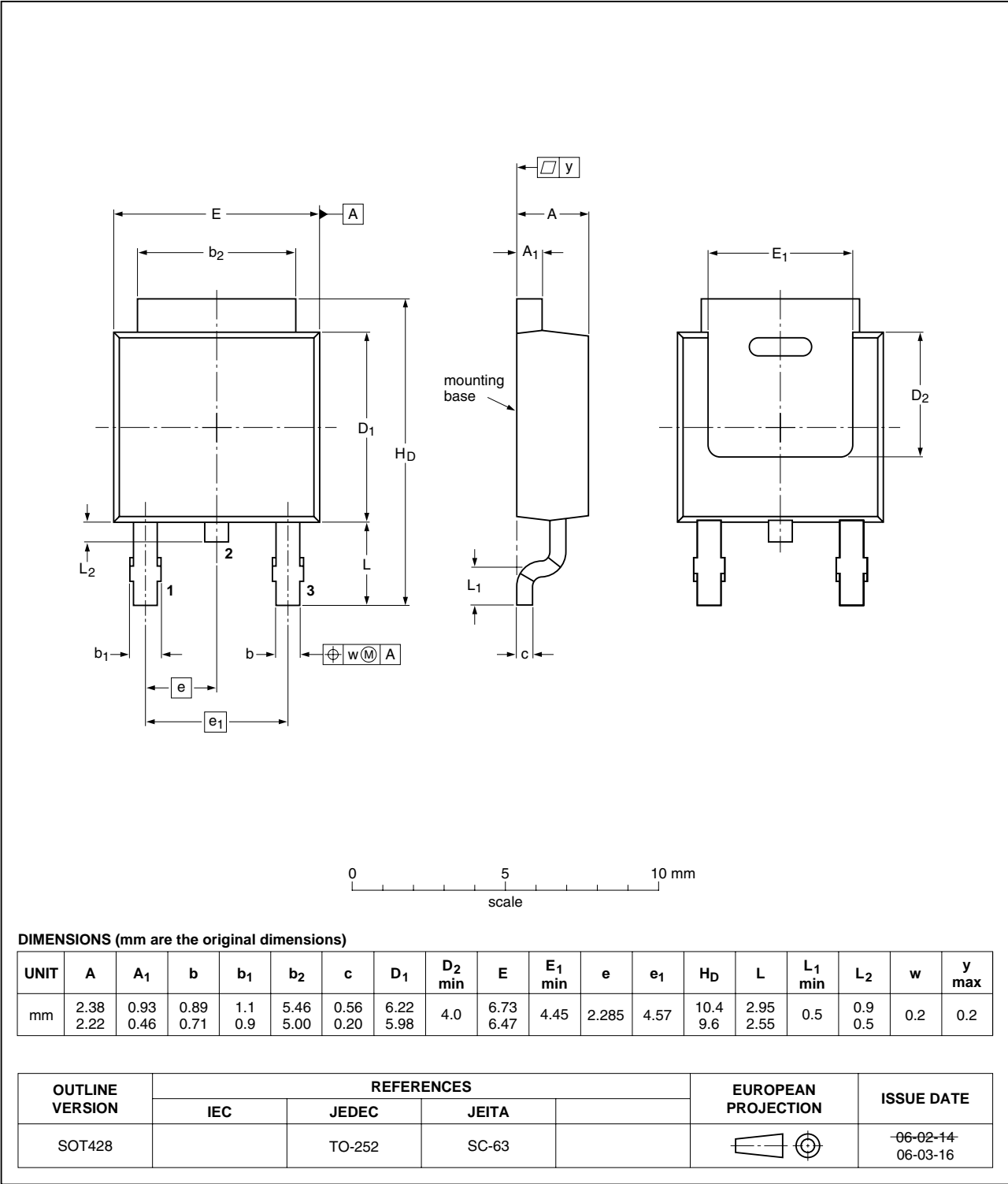


Fig 17. Package outline SOT428 (DPAK)

8. Revision history

Table 7. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|-------------|--------------|--------------------|---------------|------------|
| BUJD105AD_1 | 20090508 | Product data sheet | - | - |

9. Legal information

9.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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11. Contents

1 Product profile1

1.1 General description1

1.2 Features and benefits1

1.3 Applications1

1.4 Quick reference data1

2 Pinning information2

3 Ordering information2

4 Limiting values2

5 Thermal characteristics4

6 Characteristics5

7 Package outline9

8 Revision history10

9 Legal information11

9.1 Data sheet status11

9.2 Definitions11

9.3 Disclaimers11

9.4 Trademarks11

10 Contact information11



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